Physical and Chemical Defects in WO₃ Thin Films and Their Impact on Photoelectrochemical Water Splitting

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Abstract

We evaluate the impact of defects in WO₃ thin films on the photoelectrochemical (PEC) properties during water splitting. We study physical defects, such as micro holes or cracks, by two different deposition techniques: sputtering and atomic layer deposition (ALD). Chemical defects, such as oxygen vacancies, are tailored by different annealing atmospheres, i.e. air, N₂, and O₂. The results show that the physical defects inside the film increase the resistance for the charge transfer and also result in a higher recombination rate which inhibits the photocurrent generation. Chemical defects yield in an increased adsorption of OH groups on the film surface and enhance the PEC efficiency. Excess amount of chemical defects can also inhibit the electron transfer, thus decreasing the photocurrent generation. In this study, the highest performance was obtained for WO₃ films deposited by ALD and annealed in air, which have the least physical defects and an appropriate amount of oxygen vacancies.

Keywords: WO₃, atomic layer deposition (ALD), sputtering, defects, electron transport, photoelectrochemical water splitting

1. Introduction

Converting sunlight into chemical fuels is a promising pathway for the utilization of renewable energy, which could potentially ease the dependence on fossil fuels and contribute to resolving global warming¹⁻³. Hydrogen production from photoelectrochemical (PEC) water splitting using semiconductor photoelectrodes has been widely studied since the first discovery in 1972⁴.
During the past decades, great effort has been devoted towards exploiting efficient and robust photoelectrode materials\textsuperscript{5–9}. As a photoanode material, tungsten oxide (WO\textsubscript{3}) has been strongly investigated due to its high electron mobility (~12 cm\textsuperscript{2}V\textsuperscript{-1}s\textsuperscript{-1} at RT), suitable band-gap (2.6-2.9 eV), and good chemical stability\textsuperscript{10–13}.

Despite these promising features, the conversion efficiency of the reported WO\textsubscript{3} photoanodes is still far below the theoretical maximum conversion efficiency of 6.3\%\textsuperscript{14–18}. This is attributed to its low light harvesting efficiency and high electron-hole recombination rate. Several studies have focused on overcoming these issues, such as selective doping of metal and non-metal semiconductors\textsuperscript{19,20}, adding of co-catalysts, like CoO\textsubscript{x} or Co-Pi, to improve the water oxidation kinetics\textsuperscript{21,22}, forming a heterojunction via introduction of another semiconductor layer, like BiVO\textsubscript{4}, Bi\textsubscript{2}S\textsubscript{3}, Cu\textsubscript{2}O, to enhance the electron transport properties\textsuperscript{23–25}, or using nano/micro-structured substrates\textsuperscript{26,27}. Various thin film deposition techniques have been used to achieve improved film structures, including hydrothermal method\textsuperscript{28}, sputtering\textsuperscript{29}, pulsed laser deposition (PLD)\textsuperscript{30}, and atomic layer deposition (ALD)\textsuperscript{14}.

Another important aspect that has not been paid enough attention yet is that the quality of the thin film can significantly affect the PEC properties. During PEC water splitting, the photo-excited holes are transferred from the bulk to the surface of the WO\textsubscript{3} film for water oxidation, while the electrons are transferred to the external circuit through the functional thin film. Thus, physical defects, such as micro holes or cracks in the film can impact the photocatalytic activity and charge transfer efficiency\textsuperscript{11,14}. It is known in PEC water splitting that open porosity can increase the conversion efficiency by increasing the specific surface area\textsuperscript{11,31,32}. However, the physical defects inside the film and the interface between the functional layer and the electron collecting layer can also impede electron transport which is often not considered. Chemical defects, such as oxygen vacancies, play a sensitive role in photocatalysis as well\textsuperscript{33–35}. Oxygen vacancies in WO\textsubscript{3} films can act for example as electron donor to enhance the PEC efficiency\textsuperscript{12,36}. In recent density functional theory (DFT) studies on the electrochemical activity of WO\textsubscript{3} and Fe\textsubscript{2}O\textsubscript{3}, oxygen vacancies were found to strongly impact the overpotential\textsuperscript{37,38}. A reduction of the overpotential of 0.2 V was found for Fe\textsubscript{2}O\textsubscript{3} (110) in\textsuperscript{38} depending on the density of oxygen vacancies. The overpotential is a measure for the electrochemical activity and has therefore direct impact on the performance. Hence, the performance can be tailored by the chemical defects. Systematic, experimental studies on the impact of oxygen vacancies related to the electrode processing have not been done so far. It is therefore important to relate the physical and chemical defects of the WO\textsubscript{3} film
to the PEC properties and from this to conclude about how to design and fabricate high performing electrodes for PEC water splitting.

To this aim, we systematically evaluate the impact of defects in WO$_3$ thin films on the PEC properties during water splitting. We study the physical defects by comparing the properties of WO$_3$ thin films deposited by sputtering and ALD, respectively. The chemical defects are evaluated by different annealing atmospheres (air, N$_2$ and O$_2$). By this, systematic insight into the relation between film quality and PEC performance of thin film photoelectrodes is gained which will guide towards design rules for high performing photoelectrodes.

2. Experimental section

2.1. WO$_3$ films deposition

WO$_3$ thin films were deposited by reactive radio frequency (RF) sputtering and by plasma-enhanced ALD on commercial fluorine-doped tin oxide (FTO) (about 400 nm) coated 1 mm thick glass substrates (FTO15, Pilkington). Before the deposition, the substrates were cleaned following the procedure described in Malviya et al. Sputtered WO$_3$ films were deposited by a RF sputtering tool from Kurt J. Lesker using a 2 in. metallic tungsten target with a target-substrate distance of 95 mm. The main deposition parameters are listed in Table 1.

A FlexAL ALD reactor from Oxford Instruments, equipped with an inductively coupled plasma (ICP) source, was used to deposit WO$_3$. The metalorganic precursor $(t$BuN)$_2$(Me$_2$N)$_2$W (99% purity, Sigma Aldrich) was used as the tungsten source and O$_2$ plasma was used as the co-reactant. The main parameters of the ALD process are listed in Table 2. The plasma enhanced ALD process is described in detail in.

Table 1
Sputtering process parameters for WO$_3$ deposition.

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Value</th>
</tr>
</thead>
<tbody>
<tr>
<td>Target power</td>
<td>100 W</td>
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<tr>
<td>Base pressure</td>
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<tr>
<td>Deposition pressure</td>
<td>$10^{-2}$ mbar</td>
</tr>
<tr>
<td>Substrate temperature</td>
<td>Room temperature</td>
</tr>
</tbody>
</table>
TABLE 2
ALD process parameters for WO₃ deposition.

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Value</th>
</tr>
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<tbody>
<tr>
<td>Base pressure</td>
<td>&lt;10⁻⁶ mbar</td>
</tr>
<tr>
<td>Table temperature</td>
<td>300°C</td>
</tr>
<tr>
<td>O₂ plasma power</td>
<td>250 W</td>
</tr>
<tr>
<td>Precursor dosing</td>
<td>3 s</td>
</tr>
<tr>
<td>Coreactant O₂ plasma exposure</td>
<td>3 s</td>
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2.2. Annealing

All WO₃ films were annealed at 450°C for 1 h with a ramping rate of 5°C/min using a tubular furnace with quartz tube (Carbolite Gero). Different annealing atmospheres were used by tuning the gas flow rate: pure N₂ (15 sccm), and pure O₂ (15 sccm) and air (12 sccm N₂ mixed with 3 sccm O₂). The gas flow was started 30 min prior to the annealing to guarantee a stable gas atmosphere.

2.3. Thin film characterization

The morphologies of the films were investigated by a field emission scanning electron microscope (SEM) (Zeiss Sigma, Germany) with an in-lens detector and 5 kV accelerating voltage and a probe corrected JEOL ARM200F transmission electron microscope (TEM) operated at 200 kV in high angle annular dark field (HAADF) scanning TEM (STEM) mode. Cross-sectional TEM sample preparation was performed using a focused ion beam (FIB) (FEI, the Netherlands) using a standard lift-out procedure. The crystalline phase of the thin films was characterized by a Bruker D8 Eco X-ray diffractometer (XRD) with a Cu Kα (λ = 1.5406 Å) source and a Lynx-eye detector in a grazing incidence configuration at an incident angle of 3° and in the 2θ range from 20° to 60°. The elemental compositions and the valence states of elements were analysed using a Thermo Scientific Kα X-ray photoelectron spectroscopy (XPS) setup with an Al Kα source (hν = 1486.6 eV). The binding energy was calibrated according to the
signal of adventitious carbon (binding energy = 284.8 eV). The light transmittance and absorbance of the films were investigated using a Perkin Elmer 1050 UV/Vis/NIR Spectrophotometer in the wavelength range of 250 nm to 800 nm with a step of 5 nm.

2.4. Photo-electrochemical characterization

The PEC performance was measured using a three-electrode PEC cell with a quartz window at room temperature. Illumination was provided by an AM 1.5 class A solar simulator (LCS 100, Oriel Instruments) using a 100 W Xe lamp with a calibrated illumination intensity of 100 mW cm\(^{-2}\) at the sample position. The light sources was calibrated with a calibrated reference cell and meter (Newport, model 91150V). The WO\(_3\) thin films on FTO glass substrates (working electrodes) were encapsulated in epoxy (Loctite EA 9492) resulting in an exposed active area of about 0.3 cm\(^2\). Calibrated digital images and ImageJ were used to determine the exact geometrical area of the exposed electrode surface. A coiled Pt wire (0.8 mm in thickness) and an Ag/AgCl/Sat. KCl electrode (XR 300, Radiometer Analytical) were used as the counter and reference electrode, respectively. An aqueous solution of 0.5 M H\(_2\)SO\(_4\) (pH ~0.3) was used as electrolyte. The potential of the electrode was controlled with a BioLogic SP-150 potentiostat. All potentials reported in this study are given versus reversible hydrogen electrode (RHE) through the relation\(^\text{41}\)

\[
\Phi_{\text{RHE}} = \Phi_{\text{Ag/AgCl}} + \Phi_{\text{Ag/AgCl vs RHE}}^\circ + 0.059 \times \text{pH} \tag{1}
\]

with \(\Phi_{\text{Ag/AgCl}}^\circ\) is 0.197 V versus RHE at 25°C. Linear sweep voltammetry (LSV) measurements were performed at potentials between 0.4 V and 1.6 V versus RHE at a scan rate of 10 mV s\(^{-1}\) under chopped incident light with an externally controlled shutter with a rate of 0.5 s\(^{-1}\). Electrochemical impedance spectroscopy (EIS) was carried out in the frequency range between 0.01 Hz and 10 kHz with an AC bias signal of 10 mV at a single constant potential (1.0 V vs. RHE) under simulated sun light irradiation. Intensity modulated photocurrent spectroscopy (IMPS) measurements were conducted using a Modulab Xm PhotoEchem potentiostat (Solartron Analytical) in the same cell and electrolyte as previously mentioned. Modulated illumination was provided by a high intensity light emitting diode (\(\lambda_{\text{LED}} = 405\) nm) controlled by a LED driver (Thorlabs) that allowed the superimposition of sinusoidal modulation (~ 10%) on a DC illumination. The density of DC illumination was adjusted to 40 mW cm\(^{-2}\). The bias potential was maintained at 1.23 V vs. RHE during the IMPS measurements.

3. Results and Discussion
3.1. Structural and optical properties

The GIXRD spectra of the ALD and sputtered films after annealing in air at 450°C for 1 h are shown in Figure 1. The diffraction peaks of the films agree well with monoclinic WO₃ corresponding to JCPDS No. 83-0950, indicating that monoclinic WO₃ was obtained from both ALD and sputtered WO₃ film after annealing. The ALD WO₃ film, however, has a preferred orientation in the [002] direction, while the sputtered WO₃ film is randomly oriented. The average vertical diameter d of the grains was calculated from the XRD line width using the Scherrer equation, \( d = \frac{0.9 \lambda}{\beta \cos \theta} \), where \( \lambda \) is the X-ray wavelength, \( \beta \) is the full width at half-maximum (FWHM) of the diffraction peak, and \( \theta \) is the diffraction angle. Values of d were calculated from the FWHM of the [002] peaks for sputtered and ALD WO₃ resulting in similar average vertical diameters of 28.2 nm and 30.4 nm, respectively.

![Figure 1. GIXRD spectra of ALD (black) and sputtered (red) WO₃ thin films after annealing in air. The brown diamonds and the blue dots are monoclinic WO₃ (JCPDS No. 83-0950) and FTO (JCPDS No. 83-0950), respectively.](image)

The optical properties of the WO₃ thin films were investigated by UV-vis spectrophotometry. Figure 2a shows the transmittance spectra of the ALD and the sputtered WO₃ thin films. It is found that the optical transmittance of the ALD film is slightly lower than that of the sputtered film. This can be attributed to the more compactly arranged WO₃ grains in the ALD film, since the film thicknesses were similar. The optical indirect band gap of the WO₃ thin films was obtained by Tauc analysis from the transmittance spectra according to the following equation:

\[
(\alpha h\nu)^{1/2} = C(h\nu - E_g)
\]

where \( \alpha \) is the optical absorption coefficient (\(-[1/d]\ln[T/100]\)), \( d \) is the film thickness, \( T \) is the optical transmittance, \( h\nu \) is the incident photon energy, \( C \) is a
constant, and $E_g$ is the optical indirect band gap energy. The optical indirect band gap of ALD and sputtered WO$_3$ thin films were obtained by extrapolation to the abscissa of the plot of $\alpha(h\nu)^{1/2}$ against $h\nu$. As shown in Figure 2b, the optical indirect band gap of the ALD and the sputtered WO$_3$ film were both close to 3.0 eV. The band gap values correspond to the reported band gap range for bulk material in the literature (2.5 – 3.1 eV)$^{40,42–44}$.

3.2. Physical defects

Physical defects, like micro-cracks, micro-holes, or disrupted structure, affect the quality of the functional thin films, especially on their application in photocatalysis$^{45–47}$. In the following, we evaluate the physical defects by comparing the properties of ALD and sputtered WO$_3$ thin films.

The microstructures of the ALD and sputtered WO$_3$ thin films after annealing in air is shown in Figure 3. The surface morphologies of ALD and sputtered WO$_3$ films are shown in Figure 3a and Figure 3b, respectively. The WO$_3$ grains of the ALD thin film have a rounded shape with a size of around 100 nm in diameter. The grains are more homogeneous and compactly arranged than the grains in sputtered WO$_3$ films. The shapes of the sputtered grains are sharp which is similar to the FTO grains (Figure S1). Many micro-holes are visible around the grains. No significant difference in the surface roughness between ALD and sputtered films was found, as proven by Atomic Force Microscope (AFM) images in Figure S2. The surface roughnesses were $R_a = 3.4$ nm and $R_a = 4.9$ nm for the ALD and the sputtered films, respectively. Figure 3c and 3d show the STEM images of the cross-sections (lower magnification images in Figure S3). The thicknesses are around 50 nm for both ALD and sputtering films. Both ALD and sputtered films show continuous layer coated on the FTO grains. However, for sputtered WO$_3$, nano-size holes are distributed inside the film and the interface
between WO₃ and FTO layer, as shown as the dark spots in Figure 3d. While for ALD WO₃ film, no obvious micro holes or the other physical defects were observed. Schematic sketches are shown in Figure 3e and Figure 3f to illustrate the different structures formed by ALD and sputtering, respectively.

The PEC activity of the ALD and sputtered WO₃ thin films were compared by measuring the photocurrent as a function of the applied potential (0.4 - 1.6 V vs. RHE) in 0.5 M H₂SO₄ under chopped AM 1.5 illumination. A photocurrent density of 0.10 mA/cm² at 1.23 V vs. RHE was obtained from the ALD WO₃ thin film (Figure 4a). This is significantly higher than the photocurrent density of 0.06 mA/cm² at 1.23 V vs. RHE for the sputtered film. As shown in Figure 4a, the dark current obtained from the sputtered WO₃ film begins to rise at 1.35 V vs. RHE, while for the ALD film the dark current remains negligible in the entire range of applied potentials. The reason can be due to the micro holes inside the film, which resulted in that the FTO was exposed to the electrolyte during the PEC measurement.
In the literature, the highest photocurrent reported was about 1.5 mA/cm² at 1.23 V vs. RHE for 180 nm thick films in 1M KCl electrolyte (with HCl added to adjust the pH from 2 to 7) deposited by ALD. This higher performance is attributed to the considerably thicker films and the different electrolyte. WO₃ has a large hole diffusion length (ca. 150 nm). Therefore, within a certain range, thicker films can harvest more light without causing a significantly increase in charge recombination rate. For sputtered WO₃ films reported from the literature, the photocurrent densities of flat WO₃ in the literature scattered between 0.03 mA/cm² and 0.1 mA/cm² at 1.23 V vs. RHE, which were measured by the same method with film thicknesses between 100 nm and 500 nm. Hence, our sputtered WO₃ thin films with a thickness of only 50 nm are higher quality than those mentioned in current literature.

The higher photocurrents obtained from ALD WO₃ films in this study can be attributed to three factors: The first and the main factor is that due to its self-limiting nature, the ALD films have a more perfect interface with the FTO and less physical defects inside the film (refer to Figure 3). Physical defects can act as obstacles for the photo-generated charge carrier transfer. This is confirmed by the impedance measurements at a single constant potential (1.0 V vs. RHE) under continuous light illumination (under dark condition in Figure S4). As shown in Figure 4b, the plots represent the experimental data and the solid lines represent the fitting results. The data was fitted with an equivalent circuit consisting of a resistance (Rseries) and two RC elements (RSCBulk and RCTCH) in series (inset in Figure 4b). The EIS spectra at the high frequency (RSCBulk) is assigned to the electronic processes occurring in the WO₃ bulk. The low frequency part of the spectrum (RCTCH) is assigned to the phenomena occurring at the WO₃/electrolyte interface. The fitting values of the overall resistance (Rseries + RSC + RCT) of the ALD WO₃ photoelectrode is 18 kΩ which is lower than that of sputtered WO₃ being 28 kΩ.

The second factor is related to the preferred (002) orientation of the ALD film. It is reported that the (002) facets of monoclinic WO₃ remarkably enhance the electron mobility by reducing the recombination of electron-hole pairs, which was attributed to its lower free energy changing in the electron transfer. Third, the slightly higher light harvesting efficiency of the ALD thin film found from the absorbance spectra (Figure 2a) related to its compactly arranged WO₃ grains, might also have enhanced the photocurrent.

A more detailed look at the voltammogram under chopped light at 0.8 - 1.2 V vs. RHE is shown in Figure 4c and 4d. Once the light is switched on, the photocurrent rapidly increases for both ALD and sputtered films. For ALD film, the current follows a plateau-like behaviour (Figure 4c), while for the sputtered
film, distinct spikes are seen (Figure 4d). The spikes imply that fast recombination of the photo-generated carriers occurs\textsuperscript{55}. To confirm this, photoluminescence (PL) measurements were carried out to investigate the recombination of photo-generated charge carriers. Figure S5 shows the PL spectra of the ALD film, the sputtered film, and the blank FTO. The emission peaks at 415 nm can be attributed to the recombination of the photo-generated electron-hole pairs in the WO\textsubscript{3} film\textsuperscript{56}. This is in accordance with the bandgap value 3.0 eV obtained by the Tauc plots (Figure 2b). The PL intensity of the ALD WO\textsubscript{3} film is lower than that of the sputtered film, indicating a lower recombination rate of photo-generated electron-hole pairs.

To further understand this process, Intensity Modulated Photocurrent Spectroscopy (IMPS) was carried out to study the charge transport properties. Figure 4e shows a complex plane plot of the IMPS spectrum for both ALD and sputtered WO\textsubscript{3} thin films. The response appears in two quadrants of the complex plane. Accordingly, the frequency at the apex of the semicircle is related to the time constant of the charge transfer process\textsuperscript{23}. The average time photogenerated electrons need to reach the back contact, the electron transit time, \( \tau_D \), can be estimated from the following equation\textsuperscript{57}:

\[
\tau_D = (2\pi f_{\text{min}})^{-1}
\]  

(3)

where \( f_{\text{min}} \) is the frequency at which the minimum in the IMPS plot occurs. The \( f_{\text{min}} \) of the ALD and sputtered WO\textsubscript{3} are 10 kHz and 5 kHz, respectively. \( \tau_D \) of the ALD and sputtered WO\textsubscript{3} films are \( \tau_D \) (ALD) = 1.6×10\textsuperscript{-2} ms and \( \tau_D \) (sputtering) = 3.2×10\textsuperscript{-2} ms, respectively. These \( \tau_D \) values are lower than that those reported in the literatures, which are around 1 - 20 ms\textsuperscript{23,58}, which were measured with similar methods and same light sources. The main reason for this difference might be related to the single and much thinner WO\textsubscript{3} layer of 50 nm in this work compared to the literature (1 - 2 \( \mu \)m). The electron transit in the ALD WO\textsubscript{3} film is about two times faster than that in the sputtered film. Fast electron transfer can improve charge-collection efficiency and thus increase photocurrent density which corresponds to the better performance obtained from the ALD WO\textsubscript{3} film. Moreover, a smaller semicircle in the low frequency region (first quadrant) obtained from ALD film, as shown in the inset of Figure 4e, indicates a lower recombination rate of the photogenerated electrons and holes during the PEC water splitting; this corresponds to the analysis of the voltammograms (Figure 4c and d).

To evaluate the stability of the ALD and sputtered WO\textsubscript{3} film electrodes, photocurrent as function of time (Figure S6) was measured at a single constant potential (1.23 V vs. RHE). The results show that no significant degradation of the current density was found for both ALD and sputtered films during 2 h.
Figure 4. PEC characterization of ALD (black) and sputtered (red) WO₃ thin films: (a) Photocurrent density vs. applied potential curves under chopped light illumination (2 s light on and off, respectively). (b) Nyquist plots of the measured (dots) and fitted (line) impedance spectra at an applied potential of 1 V vs. RHE in the frequency range of 10⁻¹ to 3×10⁵ Hz; insets are the equivalent circuit model and the fitting values of $R_{\text{series}}$, $R_{\text{SC}}$ and $R_{\text{CT}}$; (c) and (d) are enlargements of the light-on part of the curves in (a) at 0.8 V to 1.2 V vs. RHE; (e) IMPS data at an applied potential of 1.23 V vs. RHE in the frequency range of 10⁻¹ to 10⁵ Hz (insets: enlargement of the plot in the first quadrant).

In summary, a higher performance was found for the ALD deposited films compared to the sputtered film. The main reason for the better performance of the ALD film is attributed to less physical defects inside the film and at the interface between the film and the FTO layer. Therefore, electrons transfer is not hindered and electron-hole recombination rate is low.

3.3. Chemical defects
Chemical states and chemical defects, such as the oxidation state and oxygen vacancies, play a sensitive role in the properties of WO$_3^{12,59,60}$. The strong impact of oxygen vacancies on the electrochemical activity of WO$_3$ was recently also demonstrated in recent DFT studies$^{37}$. In the following study, we annealed the as-deposited WO$_3$ thin films in different atmospheres, namely N$_2$, O$_2$, and air (synthetic air, N$_2$ mixed with O$_2$ in the ratio of 4:1), to evaluate the impact of the chemical defects on the PEC performance.

It was found that the grains in ALD films were more homogeneous and compactly arranged than those in the sputtered WO$_3$ after annealing in the three different atmospheres (Figure S7) corresponding to the comparison in Figure 1. There are no significant differences in the surface morphology among the films annealed in the three different atmospheres. Likewise, the UV-vis spectrophotometry measurements show almost overlapping light absorbance spectra, as shown in Figure S8. The results indicate similar light harvesting properties of the WO$_3$ films annealed in air, N$_2$ and O$_2$, respectively.

The GIXRD analyses (Figure S9) reveal that all the films annealed in different atmospheres show the monoclinic WO$_3$ diffraction peaks (JCPDS No. 83-0950). No phase separation or impurity phases were observed in the annealed samples, implying little influence on the crystal structures of the three different annealing atmospheres.

To gain more insight into the chemical defects in the WO$_3$ films inherited by the different annealing atmospheres, the chemical states of O and W were investigated by XPS (Figure S10). The relative content of each component was characterized by the fitted peak areas of the XPS pattern. It can be seen that the content of lattice O (O$_L$, centered at 530.5 eV) increases and the content of absorbed O (O$_A$, centered at 532.0 eV) decreases with the annealing atmosphere in the order: N$_2$, air and O$_2$, as shown in Figure 5a and 5b. This indicates that the concentration of hydroxyl and oxygen vacancies in the films decreased with the increasing O$_2$ partial pressure of the annealing atmosphere. In addition, the amount of W$^{6+}$ (centered at 37.8 and 35.7 eV) increases and the amount of W$^{5+}$ (centered at 36.8 and 34.7 eV) decreases with the annealing atmosphere in the order: N$_2$, air, and O$_2$ (Figure 5c and 5d) corresponding to the increasing content of O$_L$ for maintaining the charge balance. These XPS results suggest that the concentration of oxygen vacancies decreased in the WO$_3$ film with increasing O$_2$ partial pressure of annealing atmosphere.
Figure 5. Content histogram from the fitted XPS results of (a) lattice O (O\textsubscript{L}), (b) absorbed O (O\textsubscript{A}), (c) W\textsuperscript{6+}, and (d) W\textsuperscript{5+} of WO\textsubscript{3} films after annealing in different atmospheres: O\textsubscript{2}, air, N\textsubscript{2}.

The PEC results of the WO\textsubscript{3} thin films annealed in different atmospheres are illustrated in Figure 6. Both ALD and sputtered WO\textsubscript{3} thin films annealed in air show the highest photocurrent density of 0.10 mA/cm\textsuperscript{2} and 0.06 mA/cm\textsuperscript{2} at 1.23 V vs. RHE, respectively, and the films annealed in N\textsubscript{2} show the lowest photocurrent density of 0.08 mA/cm\textsuperscript{2} and 0.04 mA/cm\textsuperscript{2} at 1.23 V vs. RHE, respectively. The highest PEC conversion efficiency obtained from the WO\textsubscript{3} thin films annealed in air can be due to the synergistic effect of high concentration of hydroxyl (Figure 5) and appropriate amount of oxygen vacancies on the surface of the films. The enhancement from the oxygen vacancies is believed to be due to its role as shallow electron donor for WO\textsubscript{3} in the band gap\textsuperscript{61}. The WO\textsubscript{3} films annealed in N\textsubscript{2}, with the highest concentration of oxygen vacancies (as shown in XPS results) show, however, the lowest photocurrent densities. This can be explained by the fact that a very high amount of oxygen vacancies act as electron “traps” to inhibit the electron transfer, thus, decreasing the photocurrent generation\textsuperscript{36}. 
To confirm this explanation, the charge transfer properties of the ALD films annealed in different atmospheres were evaluated by IMPS. As shown in Figure 7, the $f_{\text{min}}$ of the ALD WO$_3$ films annealed in air, O$_2$ and N$_2$ are 10 kHz, 6.3 kHz and 5 kHz, respectively. This corresponds to electron transit times of $\tau_D = 1.6 \times 10^{-2}$ ms, $2.5 \times 10^{-2}$ ms, $3.2 \times 10^{-2}$ ms, respectively. Hence, the electron transit time is the lowest in the WO$_3$ film annealed in N$_2$ and, thus, results in the lowest photocurrent density.

A comparison of the PEC performance between films annealed in ambient air and in synthetic air is carried out in order to make sure that the origin of the
gases (gas bottle vs. ambient air) is not dominating the results and interpretations. It is found that the photocurrents are rather similar. A slightly higher photocurrent density was measured for the films annealed in ambient air compared to the films annealed in synthetic air (both for ALD and sputtered films) (Figure S11). This can be related to the content of CO₂ and H₂O in the ambient air which could form C-O or H-O groups on the surface during annealing. These groups can enhance the surface activity during the PEC conversion⁵.

4. Conclusion

The impact of physical and chemical defects in WO₃ thin film on PEC water splitting properties were studied.

The physical defects were evaluated by comparing the properties of ALD and sputtered thin films. Physical defects, like micro-holes and cracks formed during the deposition process, increased the electron transit time and also resulted in a higher recombination rate at the physical defects which inhibited the photocurrent generation. Hence, for PEC electrode fabrication, it is important to reduce the physical defects in the thin film and make perfect connection between the functional layer and the electron collection layer.

The chemical defects were evaluated by different annealing atmospheres (air, N₂ and O₂). Chemical defects, like oxygen vacancies, can generate more adsorbed OH on the surface of the film and also serve as shallow electron donor to enhance the PEC efficiency. On the other hand, excess amount of chemical defects can act as recombination centres which inhibit the electron transfer, thus, decreasing the photocurrent generation. The oxygen vacancy concentration in the WO₃ films changed according to the annealing atmosphere: N₂ > Air > O₂. The best performance was obtained from films annealed in air indicated an appropriate content of chemical defects. According to these results, it is worth to relate the annealing conditions to the content of chemical defects.

We can conclude that the selection of the thin film deposition process as well as the processing conditions, such as the annealing atmosphere, have significant impact on the performance of the thin films towards water splitting activity. Electrodes should be designed and processed in order to minimize physical defects inside the functional films and at the interface between functional layer and electron conduction layer. This demands for deposition techniques to deposit high quality, defect free thin films and interfaces. In addition, chemical defects should be well tailored, since they can impact the performance in different ways. The obtained results should be transferred from
plain thin films to nanostructured thin films in order to fabricate photoelectrodes with significant higher performance in the future.

**ASSOCIATED CONTENT**

**Supporting Information Available:** **SEM images, AFM images, STEM images, Photoluminescence (PL) spectra, Photocurrent density-time curves, UV-vis light absorbance spectra, GIXRD patterns, XPS spectra, Comparison of PEC properties in ambient air and in synthetic air**
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Graphical Abstract

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